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## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

### Details

Product Status	Active
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.7V ~ 1.9V
Number of Logic Elements/Blocks	2
Number of Macrocells	32
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4032zc-75tn48c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4032zc-75tn48c</a>

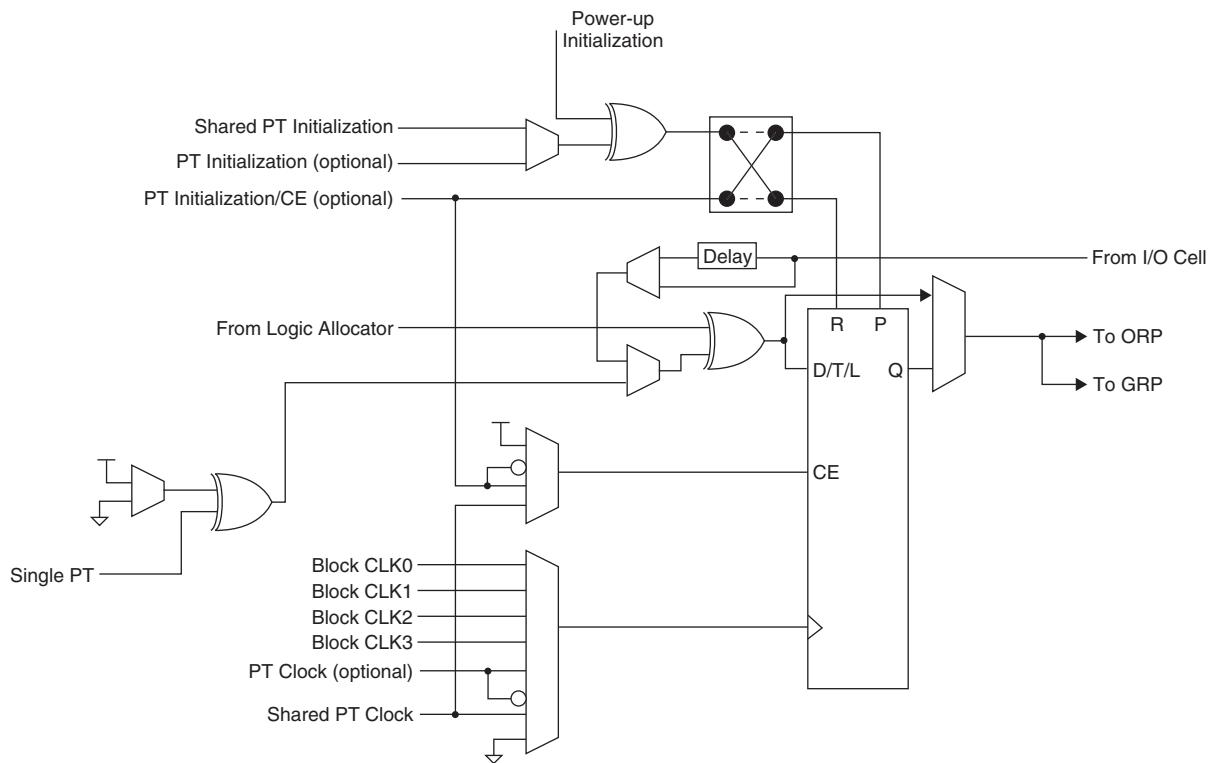
**Table 5. Product Term Expansion Capability**

Expansion Chains	Macrocells Associated with Expansion Chain (with Wrap Around)	Max PT/Macrocell
Chain-0	M0 M4 M8 M12 M0	75
Chain-1	M1 M5 M9 M13 M1	80
Chain-2	M2 M6 M10 M14 M2	75
Chain-3	M3 M7 M11 M15 M3	70

Every time the super cluster allocator is used, there is an incremental delay of  $t_{EXP}$ . When the super cluster allocator is used, all destinations other than the one being steered to, are given the value of ground (i.e., if the super cluster is steered to M (n+4), then M (n) is ground).

## Macrocell

The 16 macrocells in the GLB are driven by the 16 outputs from the logic allocator. Each macrocell contains a programmable XOR gate, a programmable register/latch, along with routing for the logic and control functions. Figure 5 shows a graphical representation of the macrocell. The macrocells feed the ORP and GRP. A direct input from the I/O cell allows designers to use the macrocell to construct high-speed input registers. A programmable delay in this path allows designers to choose between the fastest possible set-up time and zero hold time.

**Figure 5. Macrocell**

## Enhanced Clock Multiplexer

The clock input to the flip-flop can select any of the four block clocks along with the shared PT clock, and true and complement forms of the optional individual term clock. An 8:1 multiplexer structure is used to select the clock. The eight sources for the clock multiplexer are as follows:

- Block CLK0
- Block CLK1

- Block CLK2
- Block CLK3
- PT Clock
- PT Clock Inverted
- Shared PT Clock
- Ground

### Clock Enable Multiplexer

Each macrocell has a 4:1 clock enable multiplexer. This allows the clock enable signal to be selected from the following four sources:

- PT Initialization/CE
- PT Initialization/CE Inverted
- Shared PT Clock
- Logic High

### Initialization Control

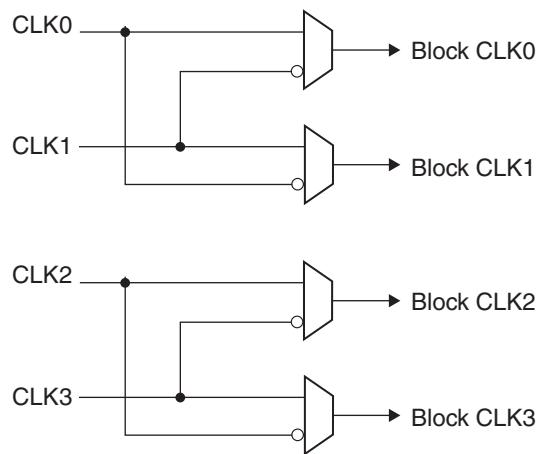
The ispMACH 4000 family architecture accommodates both block-level and macrocell-level set and reset capability. There is one block-level initialization term that is distributed to all macrocell registers in a GLB. At the macrocell level, two product terms can be “stolen” from the cluster associated with a macrocell to be used for set/reset functionality. A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility.

Note that the reset/preset swapping selection feature affects power-up reset as well. All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the block-level initialization, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the block-level initialization or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

### GLB Clock Generator

Each ispMACH 4000 device has up to four clock pins that are also routed to the GRP to be used as inputs. These pins drive a clock generator in each GLB, as shown in Figure 6. The clock generator provides four clock signals that can be used anywhere in the GLB. These four GLB clock signals can consist of a number of combinations of the true and complement edges of the global clock signals.

**Figure 6. GLB Clock Generator**



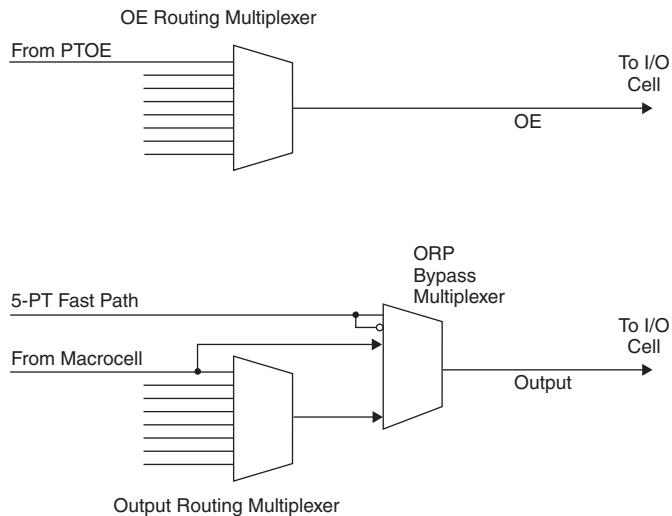
## Output Routing Pool (ORP)

The Output Routing Pool allows macrocell outputs to be connected to any of several I/O cells within an I/O block. This provides greater flexibility in determining the pinout and allows design changes to occur without affecting the pinout. The output routing pool also provides a parallel capability for routing macrocell-level OE product terms. This allows the OE product term to follow the macrocell output as it is switched between I/O cells. Additionally, the output routing pool allows the macrocell output or true and complement forms of the 5-PT bypass signal to bypass the output routing multiplexers and feed the I/O cell directly. The enhanced ORP of the ispMACH 4000 family consists of the following elements:

- Output Routing Multiplexers
- OE Routing Multiplexers
- Output Routing Pool Bypass Multiplexers

Figure 7 shows the structure of the ORP from the I/O cell perspective. This is referred to as an ORP slice. Each ORP has as many ORP slices as there are I/O cells in the corresponding I/O block.

**Figure 7. ORP Slice**



## Output Routing Multiplexers

The details of connections between the macrocells and the I/O cells vary across devices and within a device dependent on the maximum number of I/Os available. Tables 5-9 provide the connection details.

**Table 6. ORP Combinations for I/O Blocks with 8 I/Os**

I/O Cell	Available Macrocells
I/O 0	M0, M1, M2, M3, M4, M5, M6, M7
I/O 1	M2, M3, M4, M5, M6, M7, M8, M9
I/O 2	M4, M5, M6, M7, M8, M9, M10, M11
I/O 3	M6, M7, M8, M9, M10, M11, M12, M13
I/O 4	M8, M9, M10, M11, M12, M13, M14, M15
I/O 5	M10, M11, M12, M13, M14, M15, M0, M1
I/O 6	M12, M13, M14, M15, M0, M1, M2, M3
I/O 7	M14, M15, M0, M1, M2, M3, M4, M5

## Supply Current, ispMACH 4000Z (Cont.)

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>ispMACH 4256ZC</b>						
ICC <sup>1, 2, 3, 5</sup>	Operating Power Supply Current	Vcc = 1.8V, TA = 25°C	—	341	—	µA
		Vcc = 1.9V, TA = 70°C	—	361	—	µA
		Vcc = 1.9V, TA = 85°C	—	372	—	µA
		Vcc = 1.9V, TA = 125°C	—	468	—	µA
ICC <sup>4, 5</sup>	Standby Power Supply Current	Vcc = 1.8V, TA = 25°C	—	13	—	µA
		Vcc = 1.9V, TA = 70°C	—	32	55	µA
		Vcc = 1.9V, TA = 85°C	—	43	90	µA
		Vcc = 1.9V, TA = 125°C	—	135	—	µA

1. TA = 25°C, frequency = 1.0 MHz.

2. Device configured with 16-bit counters.

3. ICC varies with specific device configuration and operating frequency.

4. VCCO = 3.6V, VIN = 0V or VCCO, bus maintenance turned off. VIN above VCCO will add transient current above the specified standby ICC.

5. Includes VCCO current without output loading.

**ispMACH 4000Z External Switching Characteristics****Over Recommended Operating Conditions**

Parameter	Description <sup>1, 2, 3</sup>	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{PD}$	5-PT bypass combinatorial propagation delay	—	3.5	—	3.7	—	4.2	ns
$t_{PD\_MC}$	20-PT combinatorial propagation delay through macrocell	—	4.4	—	4.7	—	5.7	ns
$t_S$	GLB register setup time before clock	2.2	—	2.5	—	2.7	—	ns
$t_{ST}$	GLB register setup time before clock with T-type register	2.4	—	2.7	—	2.9	—	ns
$t_{SIR}$	GLB register setup time before clock, input register path	1.0	—	1.1	—	1.3	—	ns
$t_{SIRZ}$	GLB register setup time before clock with zero hold	2.0	—	2.1	—	2.6	—	ns
$t_H$	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
$t_{HT}$	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
$t_{HIR}$	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.3	—	ns
$t_{HIRZ}$	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
$t_{CO}$	GLB register clock-to-output delay	—	3.0	—	3.2	—	3.5	ns
$t_R$	External reset pin to output delay	—	5.0	—	6.0	—	7.3	ns
$t_{RW}$	External reset pulse duration	1.5	—	1.7	—	2.0	—	ns
$t_{PTOE/DIS}$	Input to output local product term output enable/disable	—	7.0	—	8.0	—	8.0	ns
$t_{GPTOE/DIS}$	Input to output global product term output enable/disable	—	6.5	—	7.0	—	8.0	ns
$t_{GOE/DIS}$	Global OE input to output enable/disable	—	4.5	—	4.5	—	4.8	ns
$t_{CW}$	Global clock width, high or low	1.0	—	1.5	—	1.8	—	ns
$t_{GW}$	Global gate width low (for low transparent) or high (for high transparent)	1.0	—	1.5	—	1.8	—	ns
$t_{WIR}$	Input register clock width, high or low	1.0	—	1.5	—	1.8	—	ns
$f_{MAX}^4$	Clock frequency with internal feedback	—	267	—	250	—	220	MHz
$f_{MAX}$ (Ext.)	clock frequency with external feedback, $[1 / (t_S + t_{CO})]$	—	192	—	175	—	161	MHz

1. Timing numbers are based on default LVC MOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.2.2

2. Measured using standard switching GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

**ispMACH 4000V/B/C Internal Timing Parameters**

Over Recommended Operating Conditions

Parameter	Description	-2.5	-2.7	-3	-3.5	Units
<b>In/Out Delays</b>						
$t_{IN}$	Input Buffer Delay	—	0.60	—	0.60	—
$t_{GOE}$	Global OE Pin Delay	—	2.04	—	2.54	—
$t_{GCLK\_IN}$	Global Clock Input Buffer Delay	—	0.78	—	1.28	—
$t_{BUF}$	Delay through Output Buffer	—	0.85	—	0.85	—
$t_{EN}$	Output Enable Time	—	0.96	—	0.96	—
$t_{DIS}$	Output Disable Time	—	0.96	—	0.96	—
<b>Routing/GLB Delays</b>						
$t_{ROUTE}$	Delay through GRP	—	0.61	—	0.81	—
$t_{MCELL}$	Macrocell Delay	—	0.45	—	0.55	—
$t_{INREG}$	Input Buffer to Macrocell Register Delay	—	0.11	—	0.31	—
$t_{FBK}$	Internal Feedback Delay	—	0.00	—	0.00	—
$t_{PDb}$	5-PT Bypass Propagation Delay	—	0.44	—	0.44	—
$t_{PDi}$	Macrocell Propagation Delay	—	0.64	—	0.64	—
<b>Register/Latch Delays</b>						
$t_S$	D-Register Setup Time (Global Clock)	0.92	—	1.12	—	1.02
$t_{S\_PT}$	D-Register Setup Time (Product Term Clock)	1.42	—	1.32	—	1.32
$t_{ST}$	T-Register Setup Time (Global Clock)	1.12	—	1.32	—	1.22
$t_{ST\_PT}$	T-Register Setup Time (Product Term Clock)	1.42	—	1.32	—	1.32
$t_H$	D-Register Hold Time	0.88	—	0.68	—	0.98
$t_{HT}$	T-Register Hold Time	0.88	—	0.68	—	0.98
$t_{SIR}$	D-Input Register Setup Time (Global Clock)	0.82	—	1.37	—	1.27
$t_{SIR\_PT}$	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45
$t_{HIR}$	D-Input Register Hold Time (Global Clock)	0.88	—	0.63	—	0.73
$t_{HIR\_PT}$	D-Input Register Hold Time (Product Term Clock)	0.88	—	0.63	—	0.73
$t_{COi}$	Register Clock to Output/Feedback MUX Time	—	0.52	—	0.52	—
$t_{CES}$	Clock Enable Setup Time	2.25	—	2.25	—	2.25
$t_{CEH}$	Clock Enable Hold Time	1.88	—	1.88	—	1.88
$t_{SL}$	Latch Setup Time (Global Clock)	0.92	—	1.12	—	1.02
$t_{SL\_PT}$	Latch Setup Time (Product Term Clock)	1.42	—	1.32	—	1.32
$t_{HL}$	Latch Hold Time	1.17	—	1.17	—	1.17
$t_{GOi}$	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—

**ispMACH 4000V/B/C Internal Timing Parameters (Cont.)**

Over Recommended Operating Conditions

Parameter	Description	-2.5		-2.7		-3		-3.5		Units
$t_{PDLi}$	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	—	0.25	ns
$t_{SRI}$	Asynchronous Reset or Set to Output/Feedback MUX Delay	0.28	—	0.28	—	0.28	—	0.28	—	ns
$t_{SRR}$	Asynchronous Reset or Set Recovery Time	1.67	—	1.67	—	1.67	—	1.67	—	ns
<b>Control Delays</b>										
$t_{BCLK}$	GLB PT Clock Delay	—	1.12	—	1.12	—	1.12	—	1.12	ns
$t_{PTCLK}$	Macrocell PT Clock Delay	—	0.87	—	0.87	—	0.87	—	0.87	ns
$t_{BSR}$	Block PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	—	1.83	ns
$t_{PTSR}$	Macrocell PT Set/Reset Delay	—	1.11	—	1.41	—	1.51	—	1.61	ns
$t_{GPOE}$	Global PT OE Delay	—	2.83	—	4.13	—	5.33	—	5.33	ns
$t_{PTOE}$	Macrocell PT OE Delay	—	1.83	—	2.13	—	2.33	—	2.83	ns

Timing v.3.2

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the Timing Model in this data sheet for further details.

**ispMACH 4000V/B/C Timing Adders<sup>1</sup> (Cont.)**

Adder Type	Base Parameter	Description	-5		-75		-10		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
$t_{INDIO}$	$t_{INREG}$	Input register delay	—	1.00	—	1.00	—	1.00	ns
$t_{EXP}$	$t_{MCELL}$	Product term expander delay	—	0.33	—	0.33	—	0.33	ns
$t_{ORP}$	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	ns
$t_{BLA}$	$t_{ROUTE}$	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b><math>t_{IOI}</math> Input Adjusters</b>									
LVTTL_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVTTL standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS33_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS25_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS18_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using LVCMOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	$t_{IN}$ , $t_{GCLK\_IN}$ , $t_{GOE}$	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b><math>t_{IOO}</math> Output Adjusters</b>									
LVTTL_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS33_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS25_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVCMOS18_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	$t_{BUF}$ , $t_{EN}$ , $t_{DIS}$	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	$t_{BUF}$ , $t_{EN}$	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

**ispMACH 4000Z Timing Adders (Cont.)<sup>1</sup>**

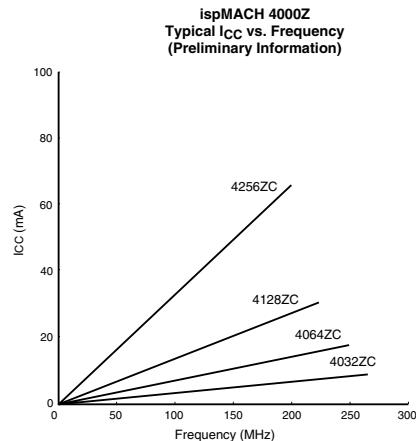
Adder Type	Base Parameter	Description	-45		-5		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.30	—	1.30	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.45	—	0.45	—	0.50	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOL</sub> Input Adjusters</b>									
LVTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTL standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVCMOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVCMOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVCMOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVCMOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVCMOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVCMOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVCMOS timing.

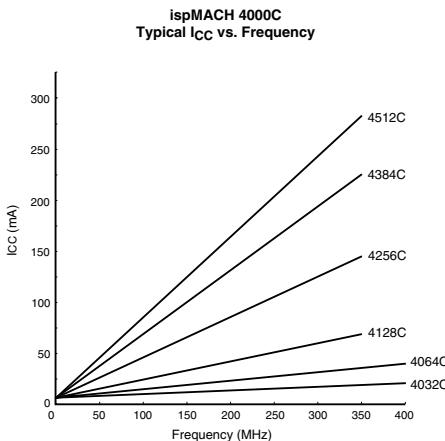
Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

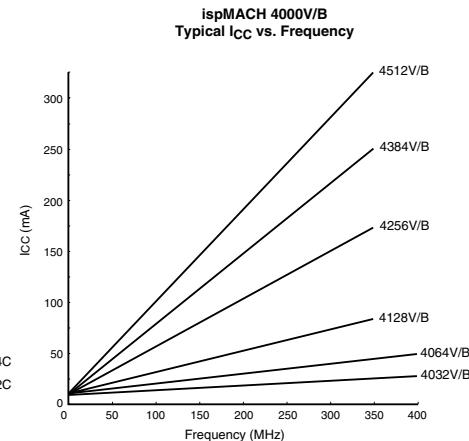
## Power Consumption



Note: The devices are configured with maximum number of 16-bit counters, typical current at 1.8V, 25°C.



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## Power Estimation Coefficients<sup>1</sup>

Device	A	B
ispMACH 4032V/B	11.3	0.010
ispMACH 4032C	1.3	0.010
ispMACH 4064V/B	11.5	0.010
ispMACH 4064C	1.5	0.010
ispMACH 4128V/B	11.5	0.011
ispMACH 4128C	1.5	0.011
ispMACH 4256V/B	12	0.011
ispMACH 4256C	2	0.011
ispMACH 4384V/B	12.5	0.013
ispMACH 4384C	2.5	0.013
ispMACH 4512V/B	13	0.013
ispMACH 4512C	3	0.013
ispMACH 4032ZC	0.010	0.010
ispMACH 4064ZC	0.011	0.010
ispMACH 4128ZC	0.012	0.010
ispMACH 4256ZC	0.013	0.010

- For further information about the use of these coefficients, refer to TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#).

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
62	1	E10	E^8
63	1	E12	E^9
64	1	E14	E^11
65	1	GND	-
66	1	TMS	-
67	1	VCCO (Bank 1)	-
68	1	F0	F^0
69	1	F1	F^1
70	1	F2	F^2
71	1	F4	F^3
72	1	F5	F^4
73	1	F6	F^5
74	1	GND (Bank 1)	-
75	1	F8	F^6
76	1	F9	F^7
77	1	F10	F^8
78	1	F12	F^9
79	1	F13	F^10
80	1	F14	F^11
81	1	VCCO (Bank 1)	-
82	1	G14	G^11
83	1	G13	G^10
84	1	G12	G^9
85	1	G10	G^8
86	1	G9	G^7
87	1	G8	G^6
88	1	GND (Bank 1)	-
89	1	G6	G^5
90	1	G5	G^4
91	1	G4	G^3
92	1	G2	G^2
93	1	G0	G^0
94	1	VCCO (Bank 1)	-
95	1	TDO	-
96	1	VCC	-
97	1	GND	-
98	1	H14	H^11
99	1	H13	H^10
100	1	H12	H^9
101	1	H10	H^8
102	1	H9	H^7
103	1	H8	H^6
104	1	GND (Bank 1)	-

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
19	0	D4	D^2	E4	E^2	G4	G^2
20	0	D2	D^1	E2	E^1	G2	G^1
21	0	D0	D^0	E0	E^0	G0	G^0
22	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
23	0	E0	E^0	H0	H^0	J0	J^0
24	0	E2	E^1	H2	H^1	J2	J^1
25	0	E4	E^2	H4	H^2	J4	J^2
26	0	E6	E^3	H6	H^3	J6	J^3
27	0	E8	E^4	H8	H^4	J8	J^4
28	0	E10	E^5	H10	H^5	J10	J^5
29	0	E12	E^6	H12	H^6	J12	J^6
30	0	E14	E^7	H14	H^7	J14	J^7
31	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
32	0	F0	F^0	J0	J^0	N0	N^0
33	0	F2	F^1	J2	J^1	N2	N^1
34	0	F4	F^2	J4	J^2	N4	N^2
35	0	F6	F^3	J6	J^3	N6	N^3
36	0	F8	F^4	J8	J^4	N8	N^4
37	0	F10	F^5	J10	J^5	N10	N^5
38	0	F12	F^6	J12	J^6	N12	N^6
39	0	F14	F^7	J14	J^7	N14	N^7
40	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
41	-	TCK	-	TCK	-	TCK	-
42	-	VCC	-	VCC	-	VCC	-
43	-	NC	-	NC	-	NC	-
44	-	NC	-	NC	-	NC	-
45	-	NC	-	NC	-	NC	-
46	-	GND	-	GND (Bank 0)	-	GND	-
47	0	G14	G^7	K14	K^7	O14	O^7
48	0	G12	G^6	K12	K^6	O12	O^6
49	0	G10	G^5	K10	K^5	O10	O^5
50	0	G8	G^4	K8	K^4	O8	O^4
51	0	G6	G^3	K6	K^3	O6	O^3
52	0	G4	G^2	K4	K^2	O4	O^2
53	0	G2	G^1	K2	K^1	O2	O^1
54	0	G0	G^0	K0	K^0	O0	O^0
55	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
56	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
57	0	H14	H^7	L14	L^7	P14	P^7
58	0	H12	H^6	L12	L^6	P12	P^6
59	0	H10	H^5	L10	L^5	P10	P^5

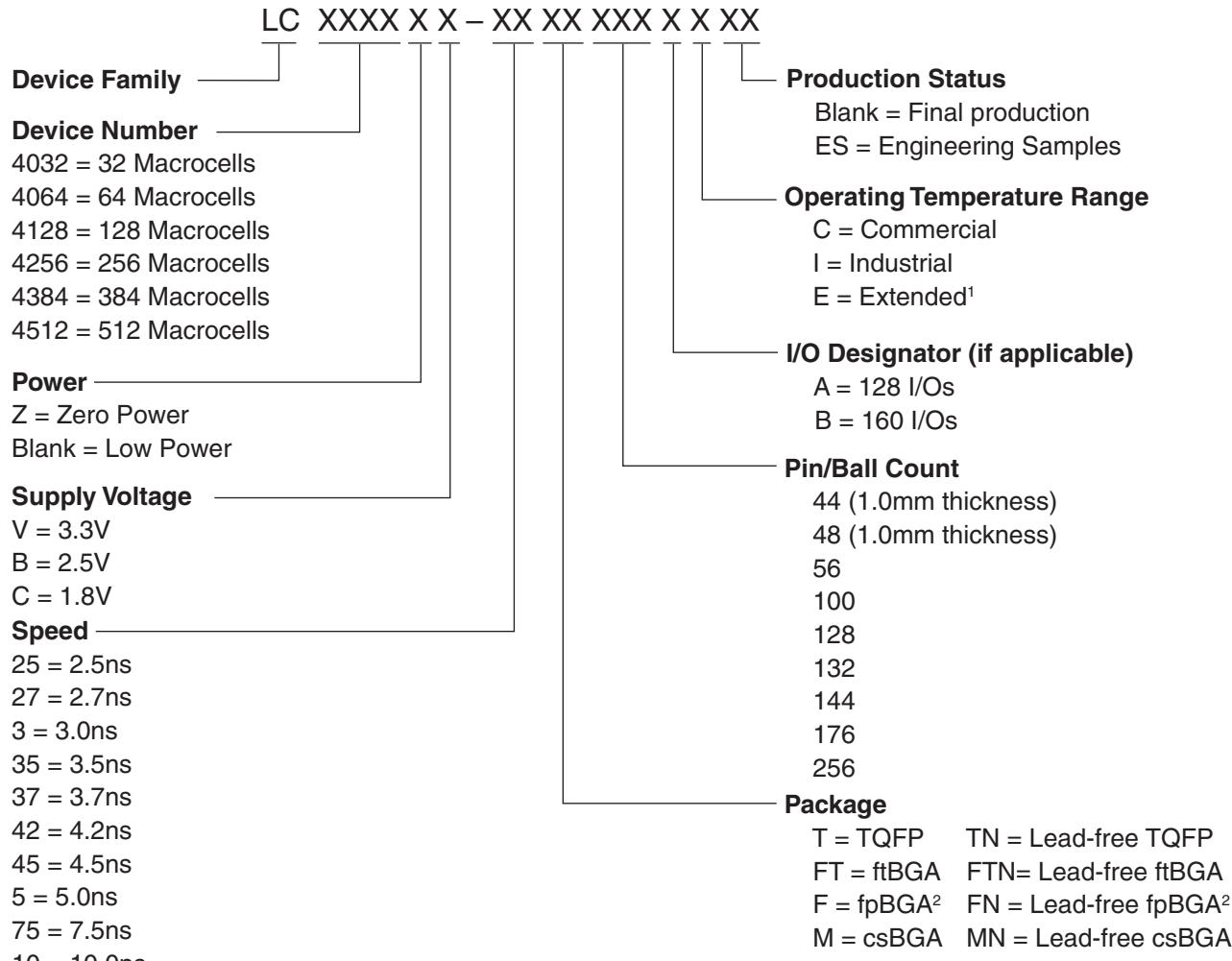
**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
60	0	H8	H^4	L8	L^4	P8	P^4
61	0	H6	H^3	L6	L^3	P6	P^3
62	0	H4	H^2	L4	L^2	P4	P^2
63	0	H2	H^1	L2	L^1	P2	P^1
64	0	H0	H^0	L0	L^0	P0	P^0
65	-	GND	-	GND	-	GND	-
66	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
67	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
68	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
69	-	VCC	-	VCC	-	VCC	-
70	1	I0	I^0	M0	M^0	AX0	AX^0
71	1	I2	I^1	M2	M^1	AX2	AX^1
72	1	I4	I^2	M4	M^2	AX4	AX^2
73	1	I6	I^3	M6	M^3	AX6	AX^3
74	1	I8	I^4	M8	M^4	AX8	AX^4
75	1	I10	I^5	M10	M^5	AX10	AX^5
76	1	I12	I^6	M12	M^6	AX12	AX^6
77	1	I14	I^7	M14	M^7	AX14	AX^7
78	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
79	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
80	1	J0	J^0	N0	N^0	BX0	BX^0
81	1	J2	J^1	N2	N^1	BX2	BX^1
82	1	J4	J^2	N4	N^2	BX4	BX^2
83	1	J6	J^3	N6	N^3	BX6	BX^3
84	1	J8	J^4	N8	N^4	BX8	BX^4
85	1	J10	J^5	N10	N^5	BX10	BX^5
86	1	J12	J^6	N12	N^6	BX12	BX^6
87	1	J14	J^7	N14	N^7	BX14	BX^7
88	-	VCC	-	VCC	-	VCC	-
89	-	NC	-	NC	-	NC	-
90	-	GND	-	GND	-	GND	-
91	-	TMS	-	TMS	-	TMS	-
92	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
93	1	K14	K^7	O14	O^7	CX14	CX^7
94	1	K12	K^6	O12	O^6	CX12	CX^6
95	1	K10	K^5	O10	O^5	CX10	CX^5
96	1	K8	K^4	O8	O^4	CX8	CX^4
97	1	K6	K^3	O6	O^3	CX6	CX^3
98	1	K4	K^2	O4	O^2	CX4	CX^2
99	1	K2	K^1	O2	O^1	CX2	CX^1
100	1	K0	K^0	O0	O^0	CX0	CX^0

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
101	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
102	1	L14	L^7	AX14	AX^7	GX14	GX^7
103	1	L12	L^6	AX12	AX^6	GX12	GX^6
104	1	L10	L^5	AX10	AX^5	GX10	GX^5
105	1	L8	L^4	AX8	AX^4	GX8	GX^4
106	1	L6	L^3	AX6	AX^3	GX6	GX^3
107	1	L4	L^2	AX4	AX^2	GX4	GX^2
108	1	L2	L^1	AX2	AX^1	GX2	GX^1
109	1	L0	L^0	AX0	AX^0	GX0	GX^0
110	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
111	1	M0	M^0	DX0	DX^0	JX0	JX^0
112	1	M2	M^1	DX2	DX^1	JX2	JX^1
113	1	M4	M^2	DX4	DX^2	JX4	JX^2
114	1	M6	M^3	DX6	DX^3	JX6	JX^3
115	1	M8	M^4	DX8	DX^4	JX8	JX^4
116	1	M10	M^5	DX10	DX^5	JX10	JX^5
117	1	M12	M^6	DX12	DX^6	JX12	JX^6
118	1	M14	M^7	DX14	DX^7	JX14	JX^7
119	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
120	1	N0	N^0	FX0	FX^0	NX0	NX^0
121	1	N2	N^1	FX2	FX^1	NX2	NX^1
122	1	N4	N^2	FX4	FX^2	NX4	NX^2
123	1	N6	N^3	FX6	FX^3	NX6	NX^3
124	1	N8	N^4	FX8	FX^4	NX8	NX^4
125	1	N10	N^5	FX10	FX^5	NX10	NX^5
126	1	N12	N^6	FX12	FX^6	NX12	NX^6
127	1	N14	N^7	FX14	FX^7	NX14	NX^7
128	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
129	-	TDO	-	TDO	-	TDO	-
130	-	VCC	-	VCC	-	VCC	-
131	-	NC	-	NC	-	NC	-
132	-	NC	-	NC	-	NC	-
133	-	NC	-	NC	-	NC	-
134	-	GND	-	GND	-	GND	-
135	1	O14	O^7	GX14	GX^7	OX14	OX^7
136	1	O12	O^6	GX12	GX^6	OX12	OX^6
137	1	O10	O^5	GX10	GX^5	OX10	OX^5
138	1	O8	O^4	GX8	GX^4	OX8	OX^4
139	1	O6	O^3	GX6	GX^3	OX6	OX^3
140	1	O4	O^2	GX4	GX^2	OX4	OX^2
141	1	O2	O^1	GX2	GX^1	OX2	OX^1

## Part Number Description



1. For automotive AEC-Q100 compliant devices, refer to the LA-ispmACH 4000V/Z Automotive Family Data Sheet (DS1017).

2. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000 Family Speed Grade Offering

	-25	-27	-3	-35	-37	-42	-45	-5		-75			-10
	Com	Ind	Com	Ind	Ext	Ind							
ispMACH 4032V/B/C													1
ispMACH 4064V/B/C													1
ispMACH 4128V/B/C													1
ispMACH 4256V/B/C													
ispMACH 4384V/B/C													
ispMACH 4512V/B/C													
ispMACH 4032ZC													1
ispMACH 4064ZC													1
ispMACH 4128ZC													1
ispMACH 4256ZC													

1. 3.3V only.

## ispMACH 4000C (1.8V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032C-75T48I	32	1.8	7.5	TQFP	48	32	I
	LC4032C-10T48I	32	1.8	10	TQFP	48	32	I
	LC4032C-5T44I	32	1.8	5	TQFP	44	30	I
	LC4032C-75T44I	32	1.8	7.5	TQFP	44	30	I
	LC4032C-10T44I	32	1.8	10	TQFP	44	30	I
LC4064C	LC4064C-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064C-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064C-10T100I	64	1.8	10	TQFP	100	64	I
	LC4064C-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064C-75T48I	64	1.8	7.5	TQFP	48	32	I
	LC4064C-10T48I	64	1.8	10	TQFP	48	32	I
	LC4064C-5T44I	64	1.8	5	TQFP	44	30	I
	LC4064C-75T44I	64	1.8	7.5	TQFP	44	30	I
	LC4064C-10T44I	64	1.8	10	TQFP	44	30	I
LC4128C	LC4128C-5T128I	128	1.8	5	TQFP	128	92	I
	LC4128C-75T128I	128	1.8	7.5	TQFP	128	92	I
	LC4128C-10T128I	128	1.8	10	TQFP	128	92	I
	LC4128C-5T100I	128	1.8	5	TQFP	100	64	I
	LC4128C-75T100I	128	1.8	7.5	TQFP	100	64	I
	LC4128C-10T100I	128	1.8	10	TQFP	100	64	I
LC4256C	LC4256C-5FT256AI	256	1.8	5	ftBGA	256	128	I
	LC4256C-75FT256AI	256	1.8	7.5	ftBGA	256	128	I
	LC4256C-10FT256AI	256	1.8	10	ftBGA	256	128	I
	LC4256C-5FT256BI	256	1.8	5	ftBGA	256	160	I
	LC4256C-75FT256BI	256	1.8	7.5	ftBGA	256	160	I
	LC4256C-10FT256BI	256	1.8	10	ftBGA	256	160	I
	LC4256C-5F256AI <sup>1</sup>	256	1.8	5	fpBGA	256	128	I
	LC4256C-75F256AI <sup>1</sup>	256	1.8	7.5	fpBGA	256	128	I
	LC4256C-10F256AI <sup>1</sup>	256	1.8	10	fpBGA	256	128	I
	LC4256C-5F256BI <sup>1</sup>	256	1.8	5	fpBGA	256	160	I
	LC4256C-75F256BI <sup>1</sup>	256	1.8	7.5	fpBGA	256	160	I
	LC4256C-10F256BI <sup>1</sup>	256	1.8	10	fpBGA	256	160	I
	LC4256C-5T176I	256	1.8	5	TQFP	176	128	I
	LC4256C-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256C-10T176I	256	1.8	10	TQFP	176	128	I
	LC4256C-5T100I	256	1.8	5	TQFP	100	64	I
	LC4256C-75T100I	256	1.8	7.5	TQFP	100	64	I
	LC4256C-10T100I	256	1.8	10	TQFP	100	64	I

## ispMACH 4000V (3.3V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-5FT256AI	256	3.3	5	ftBGA	256	128	I
	LC4256V-75FT256AI	256	3.3	7.5	ftBGA	256	128	I
	LC4256V-10FT256AI	256	3.3	10	ftBGA	256	128	I
	LC4256V-5FT256BI	256	3.3	5	ftBGA	256	160	I
	LC4256V-75FT256BI	256	3.3	7.5	ftBGA	256	160	I
	LC4256V-10FT256BI	256	3.3	10	ftBGA	256	160	I
	LC4256V-5F256AI <sup>1</sup>	256	3.3	5	fpBGA	256	128	I
	LC4256V-75F256AI <sup>1</sup>	256	3.3	7.5	fpBGA	256	128	I
	LC4256V-10F256AI <sup>1</sup>	256	3.3	10	fpBGA	256	128	I
	LC4256V-5F256BI <sup>1</sup>	256	3.3	5	fpBGA	256	160	I
	LC4256V-75F256BI <sup>1</sup>	256	3.3	7.5	fpBGA	256	160	I
	LC4256V-10F256BI <sup>1</sup>	256	3.3	10	fpBGA	256	160	I
	LC4256V-5T176I	256	3.3	5	TQFP	176	128	I
	LC4256V-75T176I	256	3.3	7.5	TQFP	176	128	I
	LC4256V-10T176I	256	3.3	10	TQFP	176	128	I
	LC4256V-5T144I	256	3.3	5	TQFP	144	96	I
	LC4256V-75T144I	256	3.3	7.5	TQFP	144	96	I
	LC4256V-10T144I	256	3.3	10	TQFP	144	96	I
	LC4256V-5T100I	256	3.3	5	TQFP	100	64	I
	LC4256V-75T100I	256	3.3	7.5	TQFP	100	64	I
	LC4256V-10T100I	256	3.3	10	TQFP	100	64	I
LC4384V	LC4384V-5FT256I	384	3.3	5	ftBGA	256	192	I
	LC4384V-75FT256I	384	3.3	7.5	ftBGA	256	192	I
	LC4384V-10FT256I	384	3.3	10	ftBGA	256	192	I
	LC4384V-5F256I <sup>1</sup>	384	3.3	5	fpBGA	256	192	I
	LC4384V-75F256I <sup>1</sup>	384	3.3	7.5	fpBGA	256	192	I
	LC4384V-10F256I <sup>1</sup>	384	3.3	10	fpBGA	256	192	I
	LC4384V-5T176I	384	3.3	5	TQFP	176	128	I
	LC4384V-75T176I	384	3.3	7.5	TQFP	176	128	I
	LC4384V-10T176I	384	3.3	10	TQFP	176	128	I
LC4512V	LC4512V-5FT256I	512	3.3	5	ftBGA	256	208	I
	LC4512V-75FT256I	512	3.3	7.5	ftBGA	256	208	I
	LC4512V-10FT256I	512	3.3	10	ftBGA	256	208	I
	LC4512V-5F256I <sup>1</sup>	512	3.3	5	fpBGA	256	208	I
	LC4512V-75F256I <sup>1</sup>	512	3.3	7.5	fpBGA	256	208	I
	LC4512V-10F256I <sup>1</sup>	512	3.3	10	fpBGA	256	208	I
	LC4512V-5T176I	512	3.3	5	TQFP	176	128	I
	LC4512V-75T176I	512	3.3	7.5	TQFP	176	128	I
	LC4512V-10T176I	512	3.3	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000B (2.5V) Lead-Free Commercial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4384B	LC4384B-35FTN256C	384	2.5	3.5	Lead-Free ftBGA	256	192	C
	LC4384B-5FTN256C	384	2.5	5	Lead-Free ftBGA	256	192	C
	LC4384B-75FTN256C	384	2.5	7.5	Lead-Free ftBGA	256	192	C
	LC4384B-35FN256C <sup>1</sup>	384	2.5	3.5	Lead-Free fpBGA	256	192	C
	LC4384B-5FN256C <sup>1</sup>	384	2.5	5	Lead-Free fpBGA	256	192	C
	LC4384B-75FN256C <sup>1</sup>	384	2.5	7.5	Lead-Free fpBGA	256	192	C
	LC4384B-35TN176C	384	2.5	3.5	Lead-Free TQFP	176	128	C
	LC4384B-5TN176C	384	2.5	5	Lead-Free TQFP	176	128	C
	LC4384B-75TN176C	384	2.5	7.5	Lead-Free TQFP	176	128	C
LC4512B	LC4512B-35FTN256C	512	2.5	3.5	Lead-Free ftBGA	256	208	C
	LC4512B-5FTN256C	512	2.5	5	Lead-Free ftBGA	256	208	C
	LC4512B-75FTN256C	512	2.5	7.5	Lead-Free ftBGA	256	208	C
	LC4512B-35FN256C <sup>1</sup>	512	2.5	3.5	Lead-Free fpBGA	256	208	C
	LC4512B-5FN256C <sup>1</sup>	512	2.5	5	Lead-Free fpBGA	256	208	C
	LC4512B-75FN256C <sup>1</sup>	512	2.5	7.5	Lead-Free fpBGA	256	208	C
	LC4512B-35TN176C	512	2.5	3.5	Lead-Free TQFP	176	128	C
	LC4512B-5TN176C	512	2.5	5	Lead-Free TQFP	176	128	C
	LC4512B-75TN176C	512	2.5	7.5	Lead-Free TQFP	176	128	C

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000B (2.5V) Lead-Free Industrial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032B	LC4032B-5TN48I	32	2.5	5	Lead-Free TQFP	48	32	I
	LC4032B-75TN48I	32	2.5	7.5	Lead-Free TQFP	48	32	I
	LC4032B-10TN48I	32	2.5	10	Lead-Free TQFP	48	32	I
	LC4032B-5TN44I	32	2.5	5	Lead-Free TQFP	44	30	I
	LC4032B-75TN44I	32	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4032B-10TN44I	32	2.5	10	Lead-Free TQFP	44	30	I
LC4064B	LC4064B-5TN100I	64	2.5	5	Lead-Free TQFP	100	64	I
	LC4064B-75TN100I	64	2.5	7.5	Lead-Free TQFP	100	64	I
	LC4064B-10TN100I	64	2.5	10	Lead-Free TQFP	100	64	I
	LC4064B-5TN48I	64	2.5	5	Lead-Free TQFP	48	32	I
	LC4064B-75TN48I	64	2.5	7.5	Lead-Free TQFP	48	32	I
	LC4064B-10TN48I	64	2.5	10	Lead-Free TQFP	48	32	I
	LC4064B-5TN44I	64	2.5	5	Lead-Free TQFP	44	30	I
	LC4064B-75TN44I	64	2.5	7.5	Lead-Free TQFP	44	30	I
	LC4064B-10TN44I	64	2.5	10	Lead-Free TQFP	44	30	I

## ispMACH 4000V (3.3V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25TN48C	32	3.3	2.5	Lead-free TQFP	48	32	C
	LC4032V-5TN48C	32	3.3	5	Lead-free TQFP	48	32	C
	LC4032V-75TN48C	32	3.3	7.5	Lead-free TQFP	48	32	C
	LC4032V-25TN44C	32	3.3	2.5	Lead-free TQFP	44	30	C
	LC4032V-5TN44C	32	3.3	5	Lead-free TQFP	44	30	C
	LC4032V-75TN44C	32	3.3	7.5	Lead-free TQFP	44	30	C
LC4064V	LC4064V-25TN100C	64	3.3	2.5	Lead-free TQFP	100	64	C
	LC4064V-5TN100C	64	3.3	5	Lead-free TQFP	100	64	C
	LC4064V-75TN100C	64	3.3	7.5	Lead-free TQFP	100	64	C
	LC4064V-25TN48C	64	3.3	2.5	Lead-free TQFP	48	32	C
	LC4064V-5TN48C	64	3.3	5	Lead-free TQFP	48	32	C
	LC4064V-75TN48C	64	3.3	7.5	Lead-free TQFP	48	32	C
	LC4064V-25TN44C	64	3.3	2.5	Lead-free TQFP	44	30	C
	LC4064V-5TN44C	64	3.3	5	Lead-free TQFP	44	30	C
	LC4064V-75TN44C	64	3.3	7.5	Lead-free TQFP	44	30	C
LC4128V	LC4128V-27TN144C	128	3.3	2.7	Lead-free TQFP	144	96	C
	LC4128V-5TN144C	128	3.3	5	Lead-free TQFP	144	96	C
	LC4128V-75TN144C	128	3.3	7.5	Lead-free TQFP	144	96	C
	LC4128V-27TN128C	128	3.3	2.7	Lead-free TQFP	128	92	C
	LC4128V-5TN128C	128	3.3	5	Lead-free TQFP	128	92	C
	LC4128V-75TN128C	128	3.3	7.5	Lead-free TQFP	128	92	C
	LC4128V-27TN100C	128	3.3	2.7	Lead-free TQFP	100	64	C
	LC4128V-5TN100C	128	3.3	5	Lead-free TQFP	100	64	C
	LC4128V-75TN100C	128	3.3	7.5	Lead-free TQFP	100	64	C

## ispMACH 4000V (3.3V) Lead-Free Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	$t_{PD}$	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75TN48E	32	3.3	7.5	Lead-free TQFP	48	32	E
	LC4032V-75TN44E	32	3.3	7.5	Lead-free TQFP	44	30	E
LC4064V	LC4064V-75TN100E	64	3.3	7.5	Lead-free TQFP	100	64	E
	LC4064V-75TN48E	64	3.3	7.5	Lead-free TQFP	48	32	E
	LC4064V-75TN44E	64	3.3	7.5	Lead-free TQFP	44	30	E
LC4128V	LC4128V-75TN144E	128	3.3	7.5	Lead-free TQFP	144	96	E
	LC4128V-75TN128E	128	3.3	7.5	Lead-free TQFP	128	92	E
	LC4128V-75TN100E	128	3.3	7.5	Lead-free TQFP	100	64	E
LC4256V	LC4256V-75TN176E	256	3.3	7.5	Lead-free TQFP	176	128	E
	LC4256V-75TN144E	256	3.3	7.5	Lead-free TQFP	144	96	E
	LC4256V-75TN100E	256	3.3	7.5	Lead-free TQFP	100	64	E

## For Further Information

In addition to this data sheet, the following technical notes may be helpful when designing with the ispMACH 4000V/B/C/Z family:

- TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#)
- TN1005, [Power Estimation in ispMACH 4000V/B/C/Z Devices](#)

## Revision History

Date	Version	Change Summary
—	—	Previous Lattice releases.
July 2003	17z	Changed device status for LC4064ZC and LC4128ZC to production release and updated/added AC and DC parameters as well as ordering part numbers for LC4064ZC and LC4128ZC devices.
		Improved leakage current specifications for ispMACH 4000Z. For ispMACH 4000V/B/C IIL, IIH condition now includes 0V and 3.6V end points ( $0 \leq V_{IN} \leq 3.6V$ ).
		Added 132-ball chip scale BGA power supply and NC connections.
		Added 132-ball chip scale BGA logic signal connections for LC4064ZC, LC4128ZC and LC4256ZC devices.
		Added lead-free package designators.
October 2003	18z	Hot socketing characteristics footnote 1. has been enhanced; Insensitive to sequence of VCC or VCCO. However, assumes monotonic rise/fall rates for Vcc and Vcco, provided $(V_{IN} - VCCO) \leq 3.6V$ .
		Improved LC4064ZC $t_S$ to 2.5ns, $t_{ST}$ to 2.7ns and $f_{MAX}$ (Ext.) to 175MHz, LC4128ZC $t_{CO}$ to 3.5ns and $f_{MAX}$ (Ext.) to 161MHz (version v.2.1).
		Improved associated internal timing numbers and timing adders (version v.2.1).
		Added ispMACH 4000V/B/C/Z ORP Reference Tables.
		Enhanced ORP information in device pinout tables consistent with the ORP Combinations for I/O Blocks tables (table 6, 7, 8 and 9 in page 9-11).
		Corrected GLB/MC/Pad information in the 256-fpBGA pinouts for the LC4256V/B/C 160-I/O version.
		Added the ispMACH 4000 Family Speed Grade Offering table.
		Added the ispMACH 4128ZC Industrial and Automotive Device OPNs
December 2003	19z	Added the ispMACH 4032ZC and 4064ZC Industrial and Automotive Device OPNs